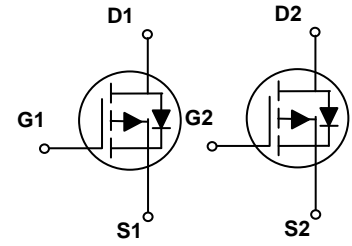
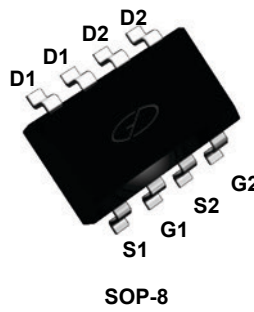


Main Product Characteristics

BV_{DSS}	-60V
$R_{DS(ON)}$	105mΩ
I_D	-4A



Schematic Diagram

Features and Benefits

- Advanced MOSFET process technology
- Ideal for high efficiency switched mode power supplies
- Low on-resistance with low gate charge
- Fast switching and reverse body recovery



Description

The GSFQ0605 utilizes the latest techniques to achieve high cell density and low on-resistance. These features make this device extremely efficient and reliable for use in high efficiency switch mode power supply and a wide variety of other applications.

Absolute Maximum Ratings ($T_C=25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Max.	Unit
Drain-Source Voltage	V_{DS}	-60	V
Gate-Source Voltage	V_{GS}	± 20	V
Drain Current-Continuous ($T_A=25^\circ\text{C}$)	I_D	-4	A
Drain Current-Continuous ($T_A=75^\circ\text{C}$)		-3.1	
Drain Current-Pulsed ¹	I_{DM}	-8	A
Power Dissipation ($T_A=25^\circ\text{C}$)	P_D	3.2	W
Power Dissipation-Derate above 25°C		0.026	
Thermal Resistance, Junction-to-Ambient	$R_{\theta JA}$	60	°C/W
Operating Junction Temperature Range	T_J	-55 To +150	°C
Storage Temperature Range	T_{STG}	-55 To +150	°C

Electrical Characteristics ($T_J=25^\circ\text{C}$ unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
On/Off Characteristics						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS}=0V, I_D=-250\mu A$	-60	-	-	V
BV_{DSS} Temperature Coefficient	$\Delta BV_{DSS}/\Delta T_J$	Reference to 25°C , $I_D=-1mA$	-	-0.05	-	$V/^\circ\text{C}$
Drain-Source Leakage Current	I_{DSS}	$V_{DS}=-60V$, $V_{GS}=0V, T_J=25^\circ\text{C}$	-	-	1	μA
		$V_{DS}=-48V$, $V_{GS}=0V, T_J=125^\circ\text{C}$	-	-	10	μA
Gate-Source Leakage Current	I_{GSS}	$V_{GS}=\pm 20V, V_{DS}=0V$	-	-	± 100	nA
Static Drain-Source On-Resistance ³	$R_{DS(ON)}$	$V_{GS}=-10V, I_D=-2A$	-	87	105	m Ω
		$V_{GS}=-4.5V, I_D=-1A$	-	120	145	
Gate Threshold Voltage	$V_{GS(th)}$	$V_{GS}=V_{DS}, I_D=-250\mu A$	-1.2	-1.5	-2.5	V
$V_{GS(th)}$ Temperature Coefficient	$\Delta V_{GS(th)}$		-	-5	-	mV/ $^\circ\text{C}$
Forward Transconductance	g_{fs}	$V_{DS}=-10V, I_D=-1A$	-	3	-	S
Dynamic and Switching Characteristics						
Total Gate Charge ^{2,3}	Q_g	$V_{DS}=-30V$, $I_D=-2A, V_{GS}=-10V$	-	10.4	15	nC
Gate-Source Charge ^{2,3}	Q_{gs}		-	1.1	1.6	
Gate-Drain Charge ^{2,3}	Q_{gd}		-	2.7	4	
Turn-On Delay Time ^{2,3}	$t_{d(on)}$	$V_{DD}=-30V$, $R_G=6\Omega$, $V_{GS}=-10V, I_D=-1A$	-	8.0	16	nS
Rise Time ^{2,3}	t_r		-	15.4	30	
Turn-Off Delay Time ^{2,3}	$t_{d(off)}$		-	42.8	80	
Fall Time ^{2,3}	t_f		-	8.4	16	
Input Capacitance	C_{iss}	$V_{DS}=-30V$, $V_{GS}=0V, F=1MHz$	-	785	1300	pF
Output Capacitance	C_{oss}		-	175	300	
Reverse Transfer Capacitance	C_{rss}		-	112	220	
Gate Resistance	R_g	$V_{GS}=0V, V_{DS}=0V$, $F=1MHz$	-	27	-	Ω
Drain-Source Diode Characteristics and Maximum Ratings						
Continuous Source Current	I_S	$V_G=V_D=0V$, Force Current	-	-	-4	A
Pulsed Source Current ³	I_{SM}		-	-	-8	A
Diode Forward Voltage ³	V_{SD}	$V_{GS}=0V$, $I_S=-1A, T_J=25^\circ\text{C}$	-	-	-1	V
Reverse Recovery Time	T_{rr}	$V_{GS}=0V, I_S=-3A$, $di/dt=100A/\mu s$, $T_J=25^\circ\text{C}$	-	52	-	nS
Reverse Recovery Charge	Q_{rr}		-	30	-	nC

Note :

1. Repetitive rating: Pulsed width limited by maximum junction temperature.
2. Pulse test: pulse width $\leq 300\mu s$, duty cycle $\leq 2\%$.
3. Essentially independent of operation temperature.

Typical Electrical and Thermal Characteristic Curves

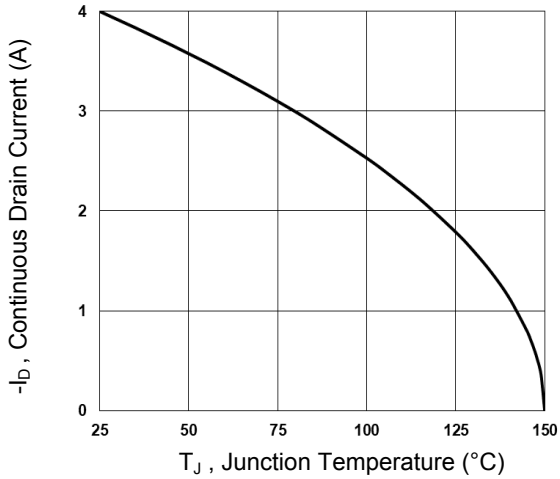


Figure 1. Continuous Drain Current vs. T_J

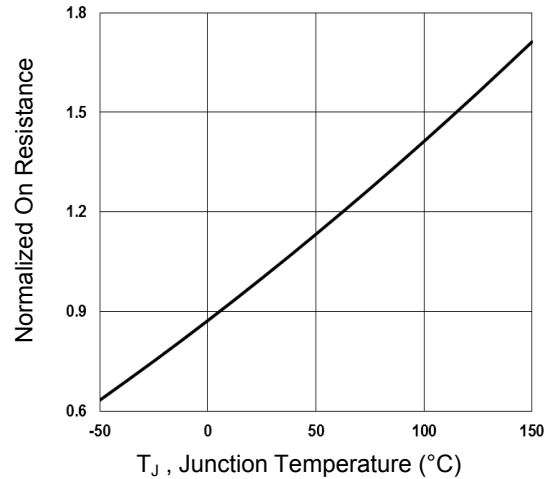


Figure 2. Normalized R_{DSON} vs. T_J

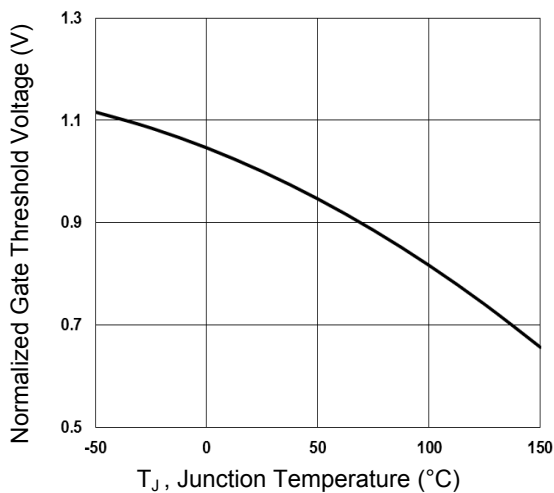


Figure 3. Normalized V_{th} vs. T_J

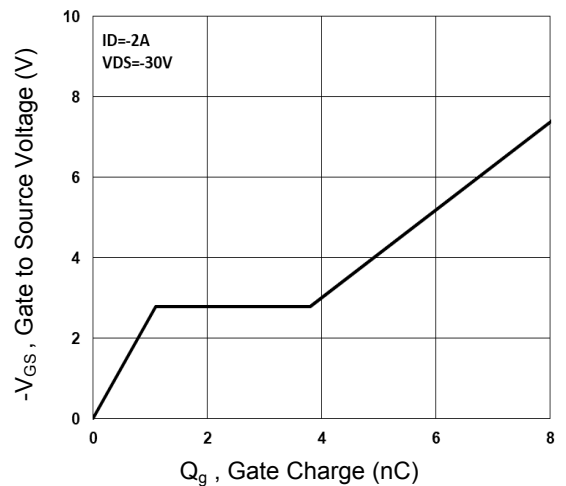


Figure 4. Gate Charge Waveform

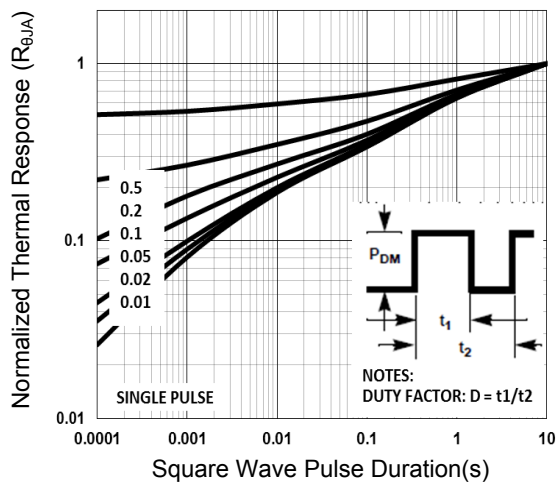


Figure 5. Normalized Transient Response

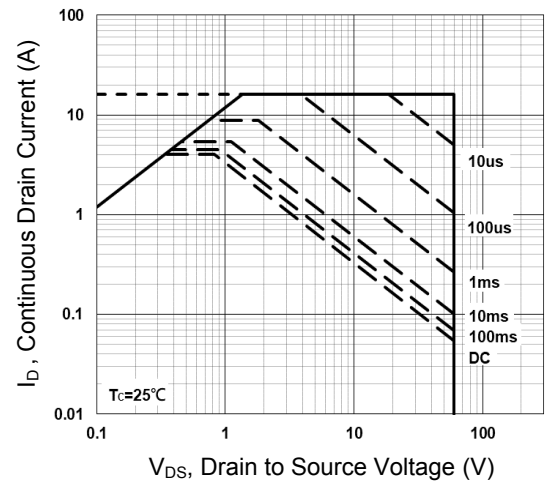


Figure 6. Maximum Safe Operation Area

Typical Electrical and Thermal Characteristic Curves

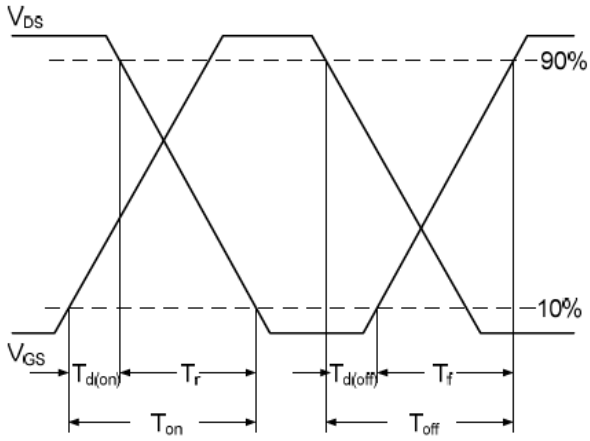


Figure 7. Switching Time Waveform

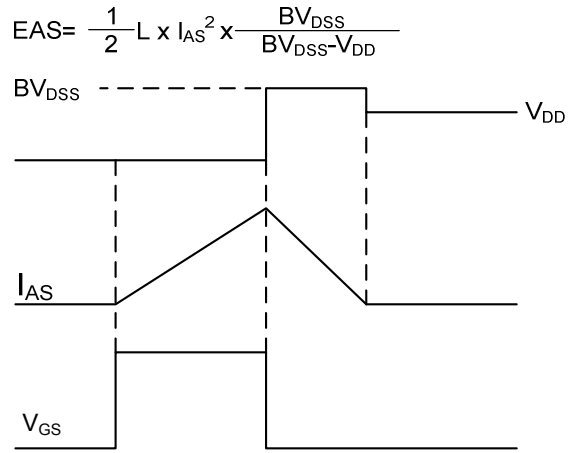
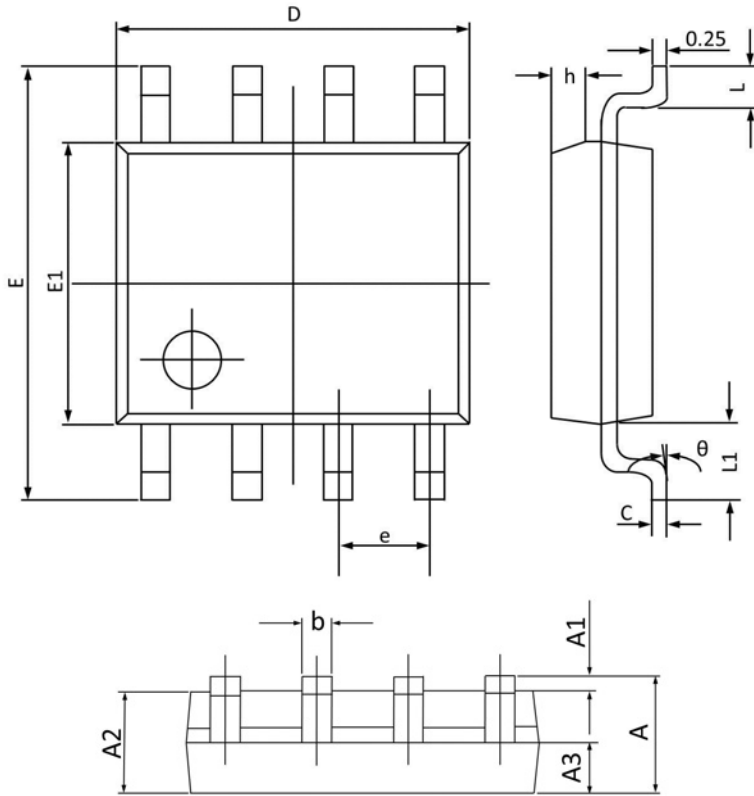


Figure 8. EAS Waveform

Package Outline Dimensions (SOP-8)



Symbol	Dimensions In Millimeters		Dimensions In Inches	
	Min	Max	Min	Max
A	1.350	1.750	0.053	0.069
A1	0.100	0.250	0.004	0.010
A2	1.250	1.650	0.049	0.065
A3	0.500	0.700	0.020	0.028
b	0.380	0.510	0.015	0.020
c	0.170	0.260	0.007	0.010
D	4.700	5.100	0.185	0.201
E	5.800	6.200	0.228	0.244
E1	3.700	4.100	0.146	0.161
e	1.270(BSC)		0.050(BSC)	
h	0.250	0.500	0.010	0.019
L	0.400	0.800	0.019	0.031
L1	1.050(BSC)		0.041(BSC)	
theta	0°	8°	0°	8°